





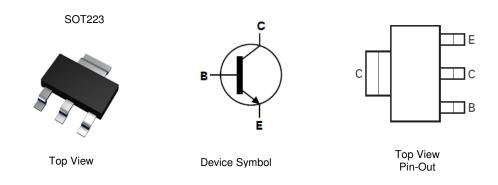
### 150V NPN MEDIUM POWER TRANSISTOR IN SOT223

### **Features**

- BV<sub>CEO</sub> > 150V
- I<sub>C</sub> = 1A High Continuous Current
- Low Saturation Voltage
- Complementary PNP Type FZT755
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

### **Mechanical Data**

- Case: SOT223
- Case Material: Molded Plastic. "Green" Molding Compound; UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads; Solderable per MIL-STD-202, Method 208 <sup>3</sup>
- Weight: 0.112 grams (Approximate)



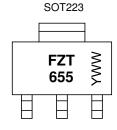
## Ordering Information (Note 4)

Product	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
FZT655TA	FZT655	7	12	1,000

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com.

# **Marking Information**



FZT 655 = Product Type Marking Code YWW = Date Code Marking Y or  $\overline{Y}$  = Last Digit of Year (ex: 5= 2015) WW or  $\overline{W}W$  = Week Code (01~53)





# **Absolute Maximum Ratings** (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	$V_{CBO}$	150	V
Collector-Emitter Voltage	V <sub>CEO</sub>	150	V
Emitter-Base Voltage	$V_{EBO}$	7	V
Continuous Collector Current	Ic	1	Α
Peak Pulse Current	I <sub>CM</sub>	2	Α

## Thermal Characteristics (@T<sub>A</sub> = +25 °C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Power Dissipation	(Note 5)	D	2	W
Fower Dissipation	(Note 6)	P <sub>D</sub>	3	W
Thermal Decistores, Junction to Ambient	(Note 5)	D	62.5	°C/W
Thermal Resistance, Junction to Ambient	(Note 6)	$R_{\theta JA}$	41.7	°C/W
Thermal Resistance, Junction to Leads (Note 7)	R <sub>0JL</sub>	19.41	°C/W	
Operating and Storage Temperature Range	$T_{J_i}T_{STG}$	-55 to +150	.€	

## **ESD Ratings** (Note 8)

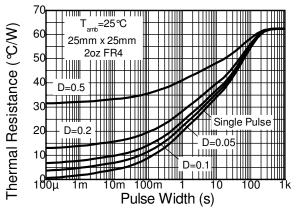
Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	4,000	V	3A
Electrostatic Discharge - Machine Model	ESD MM	400	V	С

Notes:

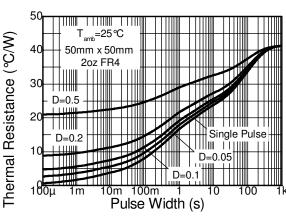
- 5. For a device mounted with the collector lead on 25mm X 25mm 2oz copper that is on a single-sided 1.6mm FR4 PCB; device is measured under still air conditions whilst operating in a steady-state.
- 6. Same as Note 5, except the device is mounted on 50mm X 50mm single sided 2oz copper.
- 7. Thermal resistance from junction to solder-point (at the end of the collector lead).
- 8. Refer to JEDEC specification JESD22-A114 and JESD22-A115.



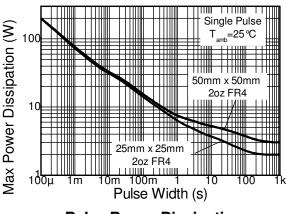
## **Thermal Characteristics and Derating Information**



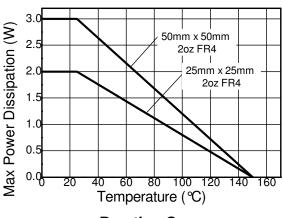
**Transient Thermal Impedance** 



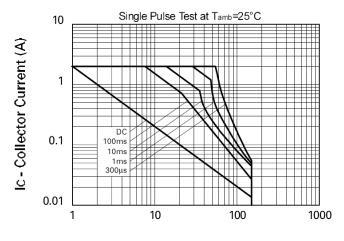
**Transient Thermal Impedance** 



**Pulse Power Dissipation** 



**Derating Curve** 



VCE - Collector Emitter Voltage (V)

# Safe Operating Area



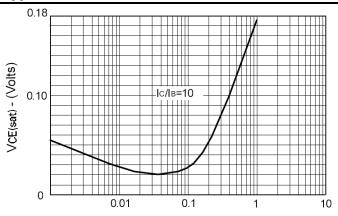


# Electrical Characteristics (@T<sub>A</sub> = +25 °C, unless otherwise specified.)

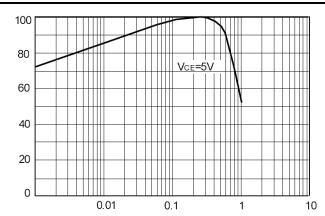
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV <sub>CBO</sub>	150	-	-	V	$I_C = 100\mu A$
Collector-Emitter Breakdown Voltage (Note 9)	BV <sub>CEO</sub>	150	_	_	V	I <sub>C</sub> = 10mA
Emitter-Base Breakdown Voltage	BV <sub>EBO</sub>	7	8.1	-	V	$I_E = 100\mu A$
Collector Cut-off Current	I <sub>CBO</sub>	-	<10	100	nA	V <sub>CB</sub> = 125V
Emitter Cut-off Current	I <sub>EBO</sub>	_	<10	100	nA	V <sub>EB</sub> = 5.6V
Collector Emitter Seturation Voltage (Note 0)	M	_	120	500	mV	$I_C = 500 \text{mA}, I_B = 50 \text{mA}$
Collector-Emitter Saturation Voltage (Note 9)	V <sub>CE(sat)</sub>	_	180	500		$I_C = 1A$ , $I_B = 200mA$
Base-Emitter Saturation Voltage (Note 9)	V <sub>BE(sat)</sub>	-	0.85	1.1	V	$I_C = 500 \text{mA}, I_B = 50 \text{mA}$
Base-Emitter Turn-On Voltage (Note 9)	V <sub>BE(on)</sub>	_	0.74	1.0	V	I <sub>C</sub> = 500mA, V <sub>CE</sub> = 5V
		50	85	_		$I_C = 10$ mA, $V_{CE} = 5$ V
DC Current Gain (Note 9)	h <sub>FE</sub>	50	100	300	_	$I_C = 500 \text{mA}, V_{CE} = 5 \text{V}$
		20	50	_		$I_C = 1A$ , $V_{CE} = 5V$
Current Gain-Bandwidth Product	f⊤	30	_	-	MHz	$V_{CE} = 20V$ , $I_{C} = 10mA$ , $f = 20MHz$
Output Capacitance (Note 9)	$C_{obo}$	_	_	20	pF	$V_{CB} = 10V$ , $f = 1MHz$

Note: 9. Measured under pulsed conditions. Pulse width  $\leq$  300 $\mu$ s. Duty cycle  $\leq$  2%.

## Typical Electrical Characteristics (@TA = +25 ℃, unless otherwise specified.)



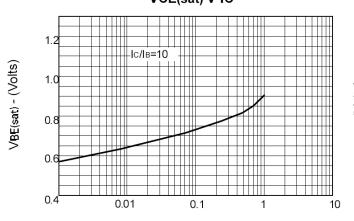
hFE - Normalised Gain (%)



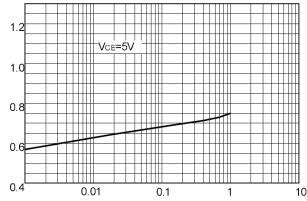
Ic - Collector Current (Amps)

Ic - Collector Current (Amps) **hFE v IC** 

# VCE(sat) v IC



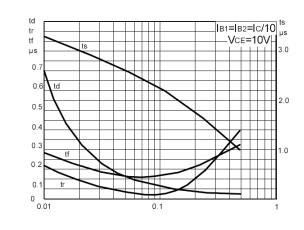
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Ic - Collector Current (Amps)

Ic - Collector Current (Amps)

## VBE(sat) v IC



VBE(on) v IC

Ic - Collector Current (Amps)

## **Switching Speeds**

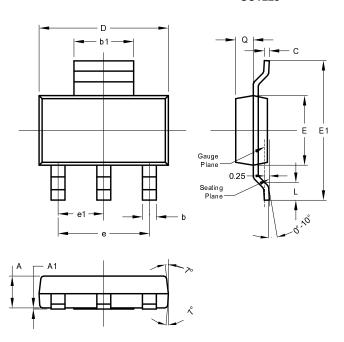
Switching time



# **Package Outline Dimensions**

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

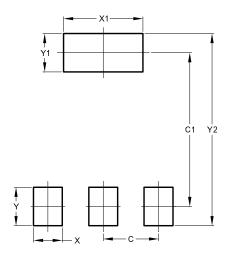
### **SOT223**



SOT223					
Dim	Min	Max	Тур		
Α	1.55	1.65	1.60		
A1	0.010	0.15	0.05		
b	20.60	30.80	0.70		
b1	2.90	3.10	03.00		
С	0.20	0.30	0.25		
D	6.45	6.55	6.50		
Е	3.45	3.55	3.50		
E1	6.90	7.10	7.00		
е		_	4.60		
e1	_	_	2.30		
L	0.85	1.05	0.95		
Q	0.84	0.94	0.89		
All Dimensions in mm					

# **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	2.30
C1	6.40
Х	1.20
X1	3.30
Y	1.60
Y1	1.60
Y2	8.00

Note: For high voltage applications, the appropriate industry sector guidelines should be considered with regards to creepage and clearance distances between device terminals and PCB tracking.





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